

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2926552

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	QUAN LI	07/02/2014
	YUCHUN HSIAO	07/02/2014
	GUOFU TANG	07/02/2014
RECEIVING PARTY DATA		
Name:	SHENZHEN CHINA STAR OPTOELECTRONICS TECHNOLOGY CO., LTD.	
Street Address:	NO.9-2, TANGMING RD, GUANGMING	
City:	SHENZHEN CITY, GUANGDONG	
State/Country:	CHINA	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14370771
CORRESPONDENCE DATA		
Fax Number:		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	909-860-8418	
Email:	ryanhcheng75866@gmail.com	
Correspondent Name:	CHENG, ANDREW CHIWU	
Address Line 1:	22928 ESTORIL DRIVE	
Address Line 2:	UNIT 5	
Address Line 4:	DIAMOND BAR, CALIFORNIA 91765	
ATTORNEY DOCKET NUMBER:	CM14035	
NAME OF SUBMITTER:	RYAN H. CHENG	
SIGNATURE:	/Ryan H. Cheng/	
DATE SIGNED:	07/05/2014	
Total Attachments: 2		
source=05_2_20141063US-CM14035_ASGN#page1.tif		
source=05_2_20141063US-CM14035_ASGN#page2.tif		

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1st Name: LI, Quan
Residing at No.9-2, Tangming Road, Guangming, Shenzhen, Guangdong, 518132, China.

2nd Name: HSIAO, Yuchun
Residing at No.9-2, Tangming Road, Guangming, Shenzhen, Guangdong, 518132, China.

3rd Name: TANG, Guofu
Residing at No.9-2, Tangming Road, Guangming, Shenzhen, Guangdong, 518132, China.

hereby Under an Obligation to sell, assign and transfer unto:

SHENZHEN CHINA STAR OPTOELECTRONICS TECHNOLOGY CO., LTD. of
SHENZHEN, GUANGDONG, CHINA (hereinafter referred as "ASSIGNEE"), its successors
and assigns, the entire right, title and interest in and to the invention known as
BACKLIGHT MODULE AND LIQUID CRYSTAL DISPLAY DEVICE (hereinafter referred as
"INVENTION"), for which a United States Patent Application was executed concurrently
herewith or, if not so executed, was:

- a. ☐ executed on _____;
b. ☐ filed on _____, Application Serial No. _____, or
c. ☒ established by PCT International Patent Application No. PCT/CN2014/079618

an application for Letters Patent of United States of America.

The undersigned agree(s) to execute all papers necessary in connection with this application for patent in the USPTO for the invention, and any continuation, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any post-grant proceeding which may occur in connection with this application or continuation, divisional or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such post-grant proceeding.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred

Signature of
1st Inventor

LI, Quan

Executed Date

Jul. 2nd, 2014

Signature of
2nd Inventor

HSIAO, YUCHUN

Executed Date

2nd, Jul, 2014

Signature of
3rd Inventor

Tang, Guofu

Executed Date

Jul. 2nd, 2014